# Bengal

# PC/104 Format Single Board Computer



## Overview

The Bengal is a low-power / high-performance single board computer (SBC) with a full complement of on-board I/O. Driven by the low power Intel® 22nm Silvermont microarchitecture, the Bengal provides up to 1.9 GHz of performance with quad, dual, and single-core processor options. Based on the industry-standard PC/104 format (4.23 x 3.77 inches), this SBC is an excellent solution for size, weight and power (SWaP) constrained applications.

Bengal is built on the new "PCIe/104 OneBank" format. Compatible with the PCI/104-Express format, it includes a legacy PCI connector, and a single bank high-speed PCIe connector. This provides flexible system expansion, while leaving more on-board space available for product features. The single bank connector is mechanically and electrically compatible with the existing PCI/104-Express Type 1 and Type 2 modules.

As with all VersaLogic products, the Bengal is designed to support OEM applications where high reliability and long-term availability are required. From application design-in support, to its 5+ year production life guarantee, the Bengal provides a durable embedded computer solution with an excellent cost of ownership.

# Highlights

- -40° to +85°C Operating Temperature
- Shock & vibration per MIL-STD-202G
- PCI/104 OneBank<sup>™</sup> form factor
- 4th Generation Intel® Atom<sup>™</sup> processor ("Bay Trail")
  - E3845 (quad core) or
  - E3826 (dual core) or
  - E3815 (single core)
- Trusted Platform Module (TPM) security chip
- Up to 8GB SO-DIMM RAM

- Gigabit Ethernet (2 ports)
- VGA and dual mini DisplayPorts
- Mini PCIe Socket / with mSATA support
- USB 3.0 and USB 2.0 ports
- Serial I/O
- SATA
- Digital I/O (18 lines)
- Fanless versions
- VersaAPI programming support
- Customization available in quantities as low as 100 pcs.



## Features

#### 1 Intel Atom "Bay Trail" Processor

Up to 1.9 GHz clock rate. Quad, dual or single core options. Low power consumption.

#### 2 High-performance Video

Integrated Intel Gen 7 graphics core supports DirectX 11, OpenGL 4.0, and H.264, MPEG-2 encoding/decoding. Analog and Dual mini DisplayPort video outputs; both outputs support multiple display modes including Extended Desktop and Clone.

#### **3** Trusted Platform Module (on back side)

On-board TPM security chip can lock out unauthorized hardware and software.

#### 4 RAM (on back side)

Up to 8 GB DDR3L socketed memory, one SO-DIMM.

#### 5 Network

Dual Ethernet interfaces, autodetect 10BaseT / 100BaseTX / 1000BaseT with remote boot support.

#### 6 Industrial I/O

OOne USB 3.0 port and five USB 2.0 ports support keyboard, mouse, and other devices. Dual RS-232/422/485 serial ports, three 8254 timer/counters, I2C, PWM output, and audio support.

#### Digital I/O

Eighteen 3.3V digital I/O lines.

#### 8 SATA

3 Gb/s SATA port supports bootable SATA hard drive.

#### 9 Mini PCle socket

Supports Wi-Fi modems, GPS receivers, flash data storage with auto-detect mSATA flash storage support, and other mini PCIe modules.

#### 10 SPI Interface

Supports SPI and SPX devices, including low cost analog and digital modules

#### 11 Main Power Input

5V Input ±5%

- Stackable Expansion (on back side)
  Legacy stack-down PCI connector.
- B Stackable Expansion (on back side) High speed stack-down PCIe/104 One Bank connector

#### Industrial Temperature

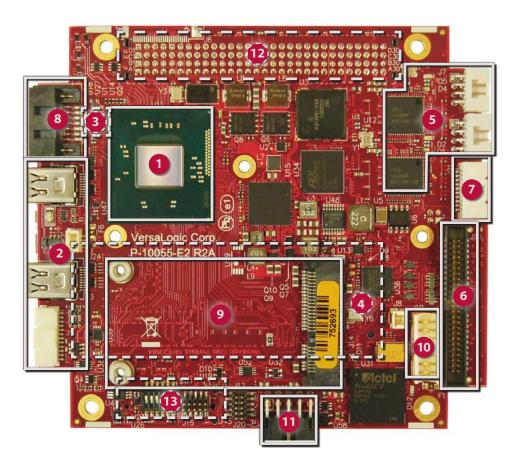
-40° to +85°C operation for harsh environments.

#### PC/104<sup>™</sup> Form Factor

Industry-standard PC/104 OneBank™ expansion.

#### MIL-STD-202G

Qualified for high shock/vibration operation.



## **Tailor Bengal to Your Exact Requirements**

Customization options are available in quantities as low as 100 pieces.

- Conformal Coating
- Custom Cabling
- Connector & I/O Changes
- Custom Testing
- Custom LabelingBGA Underfill
- BIOS Modifications
- Software and Drivers
- Revision Locks
- Custom Screening
- Application-Specific Testing
- And more –

## **Specifications**

General						
Board Size	PC/104 Compliant: 108 mm x 96 mm (4.23" x 3.77")					
Processor	Intel 4th Generation Atom E3845 (quad core), E3826 (dual core), or E3815 (single core). 512K L2 cache per core. Supports Intel 64-bit instructions, AES Instructions, Execute Disable Bit, and Virtualization Technology.					
Battery	Connector for external 3.0V RTC backup battery					
Power Requirements	Model Idle Typical Max.					
(+5V) †	VL-EPMe-30EAP	5.5	w	6.7W	7.0W	
	VL-EPMe-30EBP	6.5	W	7.0W	7.5W	
	VL-EPMe-30ECP	P 7.5W 8.7W			10.0W	
Input Voltage	5V ± 5%				·	
System Reset & Hardware Monitors	Major voltage rails monitored. Watchdog timer with programmable timeout. CPU temperature and fan speed monitoring. Push-button reset and power.					
Stackable Buses	PCI/104-Express OneBank format including: Legacy PCI connector and high speed OneBank connector (supports two PCIe x1 lanes)					
RoHS	RoHS (EU 2015/863)					
Environmental						
Cooling Options	Bolt-on heat plate standard. Optional Heat sink, Heat sink with fan, heat pipe, and other adaptors available.					
Operating	Model Heat Plate** Heat Sink Heat Sink				Heat Sink + Fan	
Temperature ◊	All Models -40°C to +85°C -40°C to +85°C -40°C to +85°C					
	Ranges shown assume 90% CPU utilization. For detailed thermal information, refer to the VL-EPMe-30 Reference Manual. **Heat plate must be kept below 90°C					
	Refer to the VL-EPMe-30 Reference Manual for detailed airflow requirements.					
Airflow Requirements		PMe-30			ual for detailed	
Requirements Storage Temperature		PMe-30			ual for detailed	
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† Represents operation at +25°C with +5V supply running Windows 7. Typical power computed as the mean value of Idle and Maximum power specifications. Maximum power is measured with 95% CPU utilization.

- Ø Derate -1.1°C per 305m (1,000 ft.) above 2,300m (7,500 ft.)
- \* For extended altitude information contact VersaLogic Sales Dept.
- ‡ TVS protected port (enhanced ESD protection)
- § Power pins on this port are overload protected
- ¥ Bootable storage device capability

n MIL-STD-202G shock and vibration levels are used to illustrate the extreme ruggedness of this product in general. Testing at higher levels and/or different types of shock or vibration methods can be accommodated per the specific requirements of the application. Contact VersaLogic Sales for further information

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Memory					
System RAM	One SO-DIMM socket. Up to 8 GB DDR3L (1.35V) SDRAM.				
Memory Speed	1066 MHz or 1333 MHz, CPU dependent				
Video General	Integrated high-performance video. Intel Gen-7 graphics core with 4 Execution Units and Turbo Boost. Supports 3 independent displays. Supports DirectX 11, OpenGL 4.0, VP8, MPEG2, H.264, VC1, 2 HD streams (1080p@30fps) Flash and WMP support.				
	Hardware Based	Format			
	Decode	H.264, MPEG2,, MPEG4, MVC, VC- 1, WMV9, VP8, MJPEG			
	Encode	H.264, MPEG2, MVC			
	support Extended I modes. Optional vi	ini DisplayPort video interfaces Desktop, Clone, and Twin display deo adapter card converts DisplayPort flat panel operation.			
VRAM	Up to 224 MB shared DRAM				
Desktop Display Interface ‡	Standard analog output (VGA). 24-bit. Up to 2560 x 1600 (60 Hz).				
DisplayPort Interface §	Support DisplayPort Standard Version 1.1 Mini DisplayPort and Mini DisplayPort++ outputs. 24-bit. Up to 2560 x 1600. Mini DisplayPort++ supports DisplayPort and HDMI signaling (Video and Audio outputs).				
Mass Storage					
Rotating Drive ¥	Single SATA (Revis	ion 2.0) port. Latching SATA connector.			
Flash / SSD ¥		ATA signaling, bootable)			
Network Interface					
Ethernet‡	Two autodetect 10BaseT/100BaseTX/1000BaseT ports. On-board status LEDs and external LED header. IEEE 1588 Precision Time Protocol (PTP) slave compatible. Latching headers				
Network Boot Option	Via on-board BIOS	extension			
Device I/O					
USB‡§	Five USB 2.0 host	ports and a single USB 3.0 host port.			
COM 1 / 2 Interface ‡	RS-232/422/485 selectable. 16C550 compatible. 460 Kbps.				
Digital I/O	Sixteen TTL I/O lines (3.3V). Independently configurable. Two General Purpose I/O lines (3.3V)				
12C	Single I2C interface				
Audio	DisplayPort and HDMI interfaces, or use optional part VL-ADR-01 Audio interface.				
Counter/Timers	Linree 8≥54 compati	ble Programmable Interval Timers (PITs).			
Other I/O					
Mini PCIe / Socket	Full-size Mini PCIe socket. Supports Wi-Fi modems, GPS receivers, non-volatile flash data storage with auto-detect mSATA support, and other plug-in modules.				
SPI Interface	Supports SPI and SPX devices. Supports up to four SPX modules.				
Software					
BIOS	Phoenix Technologies UEFI BIOS. Field reprogrammable. Support for USB keyboard/mouse and USB boot.				
VersaAPI	VersaLogic Applica support on-board l	ation Programming Interface to O devices.			
Sleep Mode	ACPI 3.0. Support C1 processor state	for S3 and S4 suspend states and .			
Operating Systems	Compatible with most x86 operating systems including Windows, Windows Embedded, Linux, VxWorks, and QNX.				



#### PC/104 Format Single Board Computer

# **Ordering Information**

#### Call VersaLogic Sales at (503) 747-2261 for more information!

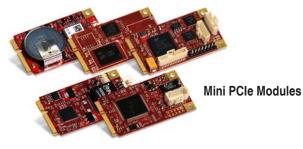
Model	Processor	Cores	Speed	DDR Max Speed	Graphics Frequency (Normal/Turbo)	Operating Temp.	Cooling	Trusted Platform Module	Conformal Coating
VL-EPMe-30EAP	Atom E3815	Single	1.46 GHz	1066 MHz	400 MHz / none	-40° to +85°C	Heat Plate	Yes	None
VL-EPMe-30EBP	Atom E3826	Dual	1.46 GHz	1066 MHz	533 MHz/ 667 MHz	-40° to +85°C	Heat Plate	Yes	None
VL-EPMe-30EBPA	Atom E3826	Dual	1.46 GHz	1066 MHz	533 MHz/ 667 MHz	-40° to +85°C	Heat Plate	Yes	Acrylic
VL-EPMe-30ECP	Atom E3845	Quad	1.91 GHz	1333 MHz	542 MHz/ 792 MHz	-40° to +85°C	Heat Plate	Yes	None

# Accessories

Part Number	Description
Cable Kit	
VL-CKR-BENGAL	Development cable kit . Includes VL-CBR-5015, 2005, 1008, 1204,
	0804 (x2), 0702, 1015, and VL-HDW-105.
VL-CBR-5015	System I/O paddleboard
VL-CBR-2005	12" 1mm 20-pin DIO cable and paddleboard
VL-CBR-1008	12" ATX power adapter cable
VL-CBR-1204	12" VGA Interface Cable, 12-pin PicoClasp Cable to 15-pin VGA
VL-CBR-0804	12" Ethernet cable (Qty. 2)
VL-CBR-0702	20" SATA cable – latching
VL-CBR-1015	1 m USB 3.0 Micro A plug to 3.0 Micro B plug
VL-HDW-105	0.6" standoff package, metric thread
Thermal Options	
VL-HDW-401	Thermal Compound Paste. For attaching heat plates and sinks.
VL-HDW-406	Passive Heat Sink to mount on product heat plate.
VL-HDW-407	Cooling fan for HDW-406 passive heat sink.
VL-HDW-408	Heat Pipe system to mount on product heat plate.
Cables	
VL-CBR-0401	6.25" ATX to SATA power cable
VL-CBR-0503	0.5 m USB 2.0 Male A to Male Micro-B Cable
VL-CBR-0701	19.75" SATA cable (non-latching)
VL-CBR-1206	18" 12-pin Pico-Clasp / 15-pin VGA, RoHS
VL-CBR-1401	Cable assembly for (2) SPX modules
VL-CBR-1402	Cable assembly for (4) SPX modules
VL-CBR-2031	36" miniDisplayPort to MiniDisplayPort
VL-CBR-2033	miniDisplayPort to HDMI Active Adapter, 6" (Commercial Temp.)
VL-CBR-2034	6" 20-pin (F) ATX to 24-pin (M) ATX adapter cable
	(use with PS-ATX12-300A)
Development	
VL-PS200-ATX	200W ATX-style power supply (20+4+4-pin ATX connector)
VL-DEV-USB-VV1	VersaViewer: A real-time viewer for embedded hardware developers
VL-PS-ATX12-300A	ATX development power supply (requires VL-CBR-2034)
Audio	
VL-ADR-01S	USB to Audio Adapter, -25° to +85°C
Memory	
VL-MM9-xxEBN	DDR3 PC3-12800 SO-DIMM memory module (1.35v)
Hardware	
VL-HDW-108	Mini PCIe Module / mSATA hardware kit (metric thread) 2.5 mm
Miscellaneous	
VL-HDW-111	Half to Full Size MiniPCIe Adapter kit. Metal adapter and screws (2)
VL-HDW-203	PC/104 extractor tool (metal)
VL-EPH-V6	Display Port to Dual Channel LVDS converter

## **Expansion Modules**

Part Number	Description	Form Factor			
Network	•				
VL-MPEe-FW1E	1394 Firewire Module, industrial temperature	Mini PCIe			
VL-MPEe-E4E	Gigabit Ethernet Over Fiber Optic media	Mini PCIe			
VL-MPEe-E3E	Gigabit Ethernet adapter	Mini PCIe			
Serial I/O					
VL-MPEe-U2E	Quad serial plus twelve GPIOs	Mini PCIe			
Analog & Digital	//0				
VL-MPEe-A1E	Analog input (12-bit resolution)	Mini PCIe			
VL-MPEe-A2E	Analog input (16-bit resolution)	Mini PCIe			
VL-SPX-1	Analog Input Module 8-Channels	SPX			
VL-SPX-2	Digital I/O Module 16-lines	SPX			
VL-SPX-4	Analog Output Module 4-channels 12-bit	SPX			
VL-SPX-5	Solid State Switch Module 8-channel	SPX			
GPS					
VL-MPEu-G2E	GPS receiver	Mini PCIe			
VL-MPEu-G3E	Precision GPS Receiver, industrial temperature				
Solid-State Storage (flash memory)					
VL-MPEs-F1Exx	mSATA module (4/16/32 GB) (SATA)	Mini PCIe			
Adapters					
VL-MPEs-S3E	SATA adapter	Mini PCIe			
VL-EPMp-P2E	Dual Mini PCIe adapter	PCI-104			



### Take the Risk out of Embedded Computing

Whether it's selecting the optimum solution for your application, providing expert support during development, or on-time delivery of defect-free products, VersaLogic is here to make sure your project goes smoothly from initial concept through the extended life of your program. Contact VersaLogic today to learn more.





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